

EXAMINED BY : Justin Horng	EMERGING DISPLAY TECHNOLOGIES CORPORATION	FILE NO . CAS-0008014
APPROVED BY : Yung Chang Hu		ISSUE : NOV.14, 2014
		TOTAL PAGE : 24
		VERSION : 1
CUSTOMER ACCEPTANCE SPECIFICATIONS		
MODEL NO. : <u>ET070006DS6</u> (GP) FOR MESSRS : _____		
CUSTOMER'S APPROVAL DATE : _____ BY : _____		

EMERGING DISPLAY
TECHNOLOGIES CORPORATION

MODEL NO.

ET070006DS6

VERSION

1

PAGE

0-1

RECORDS OF REVISION

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REVISED
PAGE
NO.

SUMMARY

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1. GENERAL SPECIFICATIONS

1.1 DATA SHEETS FOR CONTROLLER/DRIVER

PLEASE REFER TO :

HIMAX HX8262-A

HIMAX HX8678-A

1.2 MATERIAL SAFETY DESCRIPTION

ASSEMBLIES SHALL COMPLY WITH EDT GREEN PRODUCT (GP) REQUIREMENTS, INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD, MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED BIPHENYLS (PBB), POLYBROMINATED DIPHENYL ETHERS (PBDE), POLYCHLORINATED BIPHENYLS (PCB) CATEGORY, POLYCHLORINATED NAPHTHALENE (PCN) CATEGORY, POLYCHLORINATED TERPHENYLS (PCT) CATEGORY, CHLORINATED PARAFFINS (CP) CATEGORY, TRIBUTHYL TIN CATEGORY / TRIPHENYL TIN CATEGORY, ASBESTOS, SPECIFIC AZO COMPOUNDS, FORMALDEHYDE, POLYVINYL CHLORIDE (PVC) AND PVC BLENDS, OTHER BROMINATED ORGANIC COMPOUNDS AND OTHER CHLORINATED ORGANIC COMPOUNDS.

2. MECHANICAL SPECIFICATIONS

(1) DISPLAY SIZE	-----	7 inch
(2) NUMBER OF DOTS	-----	800W * (RGB) * 480H DOTS
(3) MODULE SIZE	-----	165W * 104.44H *9.85D(MAX.) mm (WITHOUT FPC)
(4) ACTIVE AREA	-----	152.4W * 91.44H mm
(5) DOT SIZE	-----	0.0635W * 0.1905H mm
(6) PIXEL SIZE	-----	0.1905W * 0.1905H mm
(7) LCD TYPE	-----	TFT, TRANSMISSIVE, ANTI-GLARE
(8) COLOR	-----	262K
(9) VIEWING DIRECTION	-----	6 O'CLOCK
(10) BACK LIGHT	-----	LED, COLOR : WHITE
(11) INTERFACE MODE	-----	RGB 18BIT PARALLEL (DE/SYNC MODE)

3. ABSOLUTE MAXIMUM RATINGS

3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS .

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	-0.5	6.5	V	
INPUT VOLTAGE	VIN-VSS	- 0.3	VDD+0.3	V	
LED BACKLIGHT POWER DISSIPATION	PD	—	6.48	W	
LED BACKLIGHT FORWARD CURRENT	IF	—	360	mA	

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS .

ITEM	OPERATING		STORAGE		REMARK
	MIN.	MAX.	MIN.	MAX.	
AMBIENT TEMPERATURE	-30°C	+80°C	-30°C	+80°C	NOTE (1), (2)
HUMIDITY	NOTE (3)		NOTE (3)		WITHOUT CONDENSATION
VIBRATION	—	2.45 m/s ² (0.25G)	—	11.76 m/s ² (1.2G)	5~20Hz , 1HR 20~500Hz(20Hz) , 1HR 20~500Hz(500Hz) , 1HR X,Y,Z,TOTAL3HRS
SHOCK	—	29.4 m/s ² (3G)	—	490 m/s ² (50G)	10 ms XYZ DIRECTIONS 1 TIME EACH
CORROSIVE GAS	NOT ACCEPTABLE		NOT ACCEPTABLE		

NOTE (1) : Ta AT -30°C : 48HRS MAX .
80°C : 168HRS MAX .

NOTE (2) : BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT TEMPERATURE
THIS PHENOMENON IS REVERSIBLE.

NOTE (3) : Ta ≤ 60°C : 90%RH MAX (96HRS MAX).
Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY
OF 90%RH AT 60°C(96HRS MAX).

4. ELECTRICAL CHARACTERISTICS

Ta = 25 °C

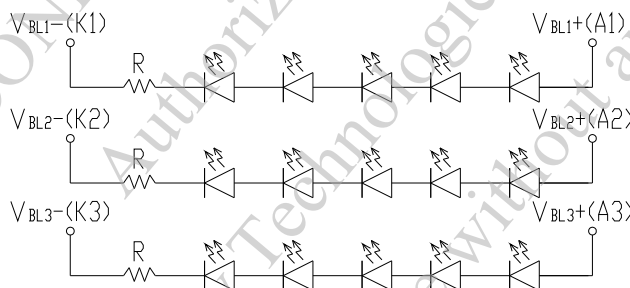
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	—	3.2	3.3	3.6	V	
POWER SUPPLY VOLTAGE FOR LED DRIVER	VCC-VSS	—	4.7	5.0	5.3	V	
LOW LEVEL INPUT VOLTAGE	VIL	—	0	—	0.3*VDD	V	NOTE (1)
HIGH LEVEL INPUT VOLTAGE	VIH	—	0.7*VDD	—	VDD	V	NOTE (1)
POWER SUPPLY CURRENT	IDD	VDD-VSS = 3.3V	—	220	270	mA	NOTE (2)
POWER SUPPLY CURRENT FOR LED DRIVER	ICC	VCC-VSS=5.0V LED B/L=ON	—	450	540	mA	
LED LIFE TIME	—	I _{LED} =50mA (PER. LED)	70K	—	—	hrs	NOTE (5) NOTE (6)

NOTE (1) : APPLIED TO TERMINALS B5~B0, G5~G0, R5~R0, DCLK, HSYNC, VSYNC, ENB.

NOTE (2) : THE DISPLAY PATTERN IS ALL "WHITE".

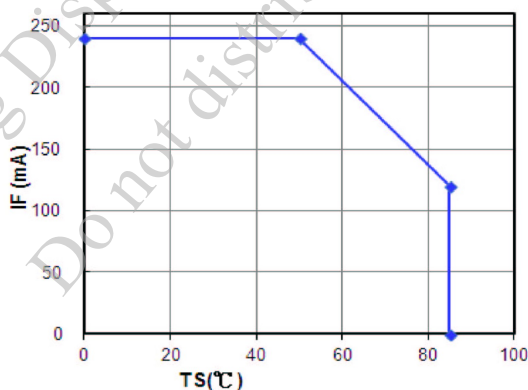
NOTE (3) : INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT.

$$(VF = V_{BL1} + (A1) - V_{BL1} - (K1) = V_{BL2} + (A2) - V_{BL2} - (K2) = V_{BL3} + (A3) - V_{BL3} - (K3))$$



15 LED CHIPS

NOTE (4) : AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT.(PER. LED)



NOTE (5) : CONDITIONS; TA=25 °C, CONTINUOUS LIGHTING.

NOTE (6) : DEFINITIONS OF FAILURE

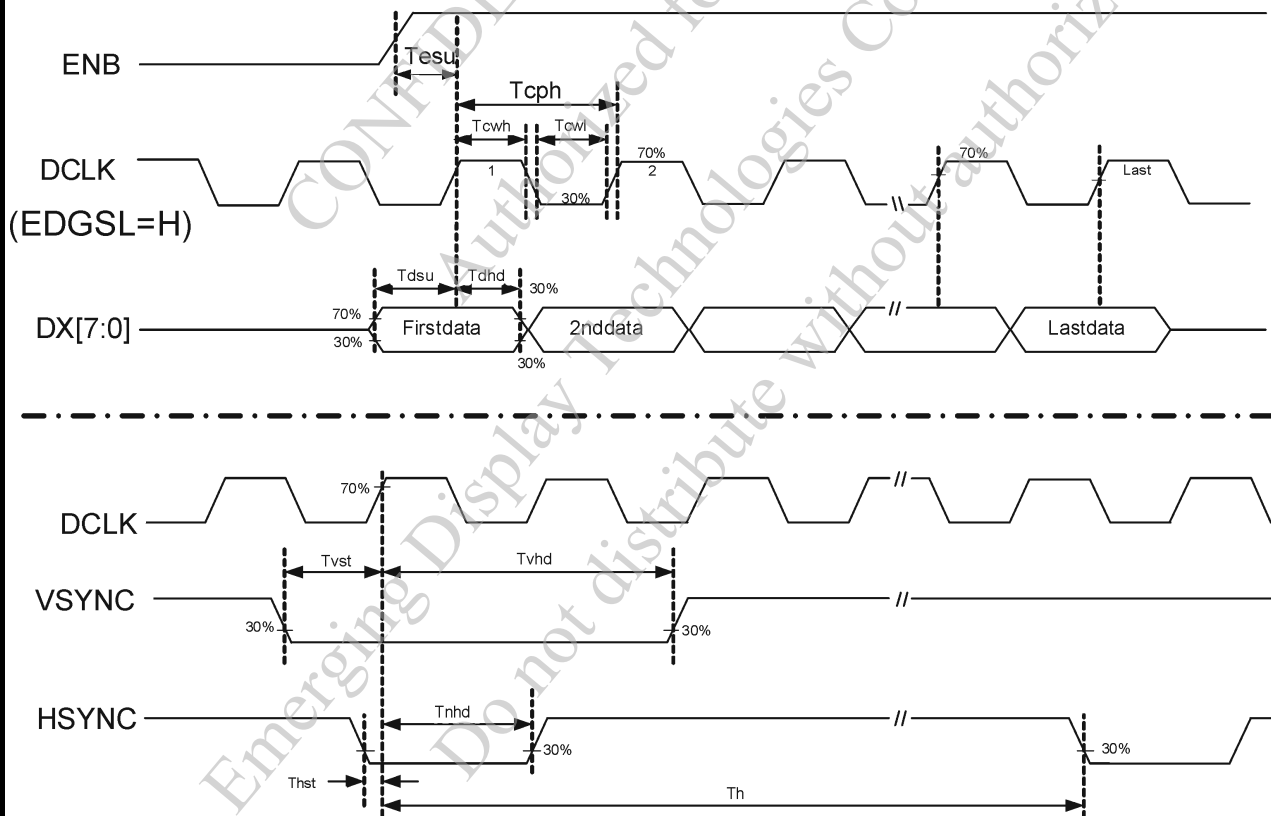
A. LCD LUMINANCE BECOMES HALF OF THE MINIMUM VALUE.

B. LED DOESN'T LIGHT NORMALLY.

5. TIMING CHARACTERISTICS

5.1 AC ELECTRICAL CHARACTERISTICS

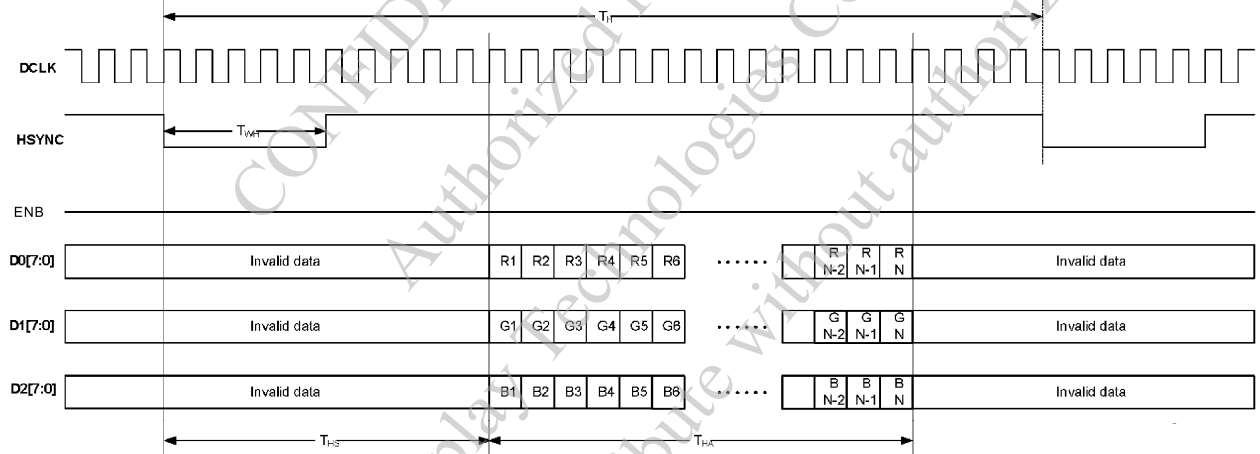
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
HSYNC SETUP TIME	T_{hst}	6	—	—	ns
HSYNC HOLD TIME	T_{hhd}	6	—	—	ns
VSYNC SETUP TIME	T_{vst}	6	—	—	ns
VSYNC HOLD TIME	T_{vhd}	6	—	—	ns
DATA SETUP TIME	T_{dsu}	6	—	—	ns
DATA HOLD TIME	T_{dhd}	6	—	—	ns
ENB SETUP TIME	T_{esu}	6	—	—	ns
SOURCE OUTPUT SETTLING TIME	T_{ST}	—	—	15	μ s
SOURCE OUTPUT LOADING R	R_{SL}	—	2	—	K ohm
SOURCE OUTPUT LOADING C	C_{SL}	—	60	—	pF



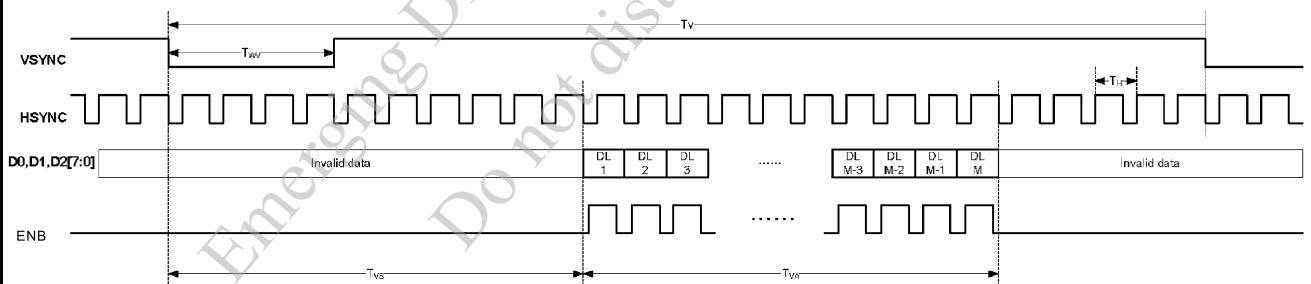
5.2 SYNC MODE SIGNAL CHARACTERISTICS

PARAMETER	SYMBOL	SPEC			UNIT
		MIN.	TYP.	MAX.	
DCLK FREQUENCY	F_{CPH}	—	33.26	—	MHz
DCLK PERIOD	T_{CPH}	—	30.06	—	ns
DCLK PULSE DUTY	T_{CWH}	40	50	60	%
HSYNC PERIOD	T_H	930	1056	1057	T_{CPH}
HSYNC PULSE WIDTH	T_{WH}	1	128	—	T_{CPH}
HSYNC -FIRST HORIZONTAL DATA TIME	T_{HS}	—	216	—	T_{CPH}
HSYNC ACTIVE TIME	T_{HA}	—	800	—	T_{CPH}
VSYNC PERIOD	T_V	—	525	—	T_H
VSYNC PULSE WIDTH	T_{WV}	1	2	—	T_H
VSYNC -DE TIME	T_{VS}	—	35	—	T_H
VSYNC ACTIVE TIME	T_{VA}	—	480	—	T_H

(EDGSL=H)



SYNC Mode Horizontal Data Format

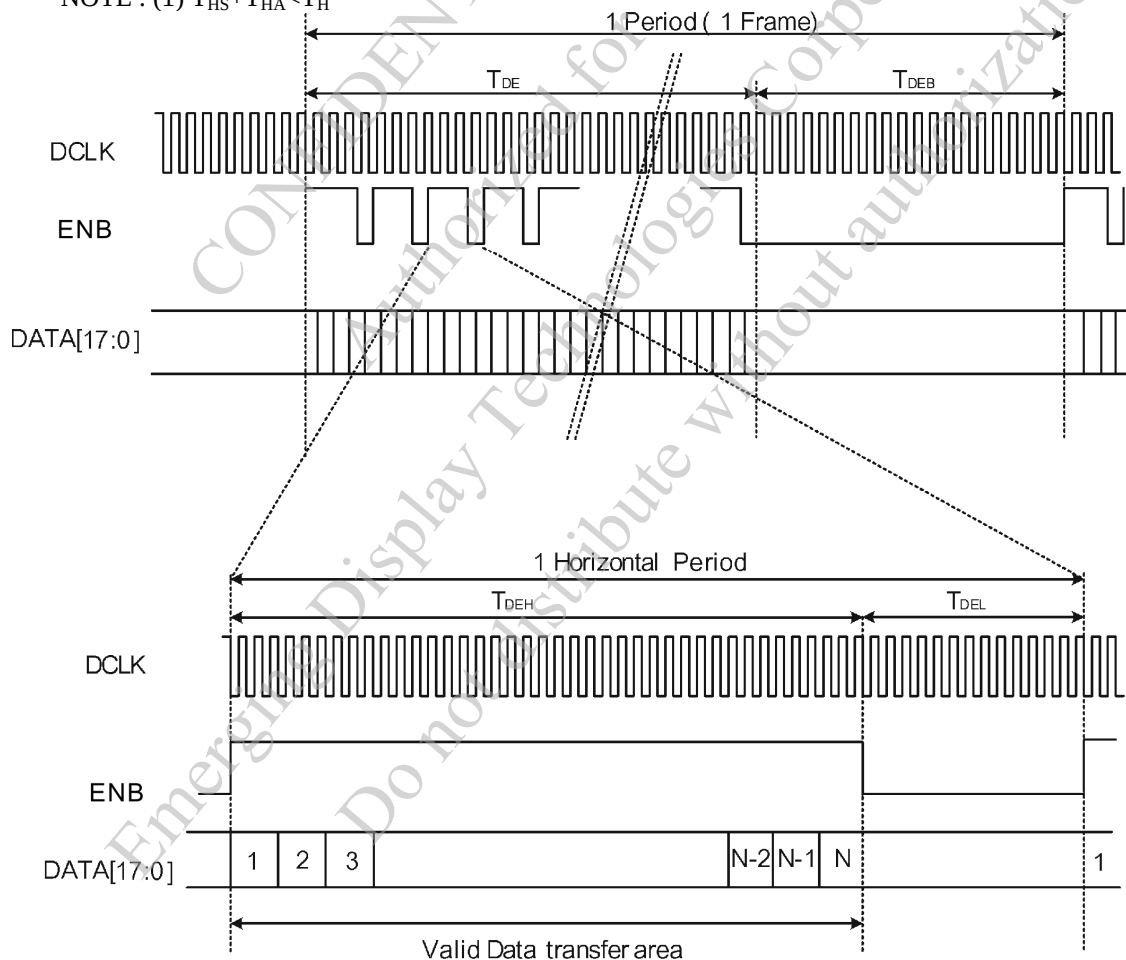


SYNC Mode Vertical Data Format

5.3 DE MODE SIGNAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQUENCY	F_{CPH}	—	33.26	—	MHz
DCLK PERIOD	T_{CPH}	—	30.06	—	ns
DCLK PULSE DUTY	T_{CWH}	40	50	60	%
ENB PERIOD	$T_{DEH} + T_{DEL}$	1000	1056	1200	T_{CPH}
ENB PULSE WIDTH	T_{DEH}	—	800	—	T_{CPH}
ENB FRAME BLANKING	T_{DEB}	10	45	110	$T_{DEH} + T_{DEL}$
ENB FRAME WIDTH	T_{DE}	—	480	—	$T_{DEH} + T_{DEL}$
OEV PULSE WIDTH	T_{OEV}	—	150	—	T_{CPH}
CKV PULSE WIDTH	T_{CKV}	—	133	—	T_{CPH}
ENB(INTERNAL)-STV TIME	T_1	—	4	—	T_{CPH}
ENB(INTERNAL)-CKV TIME	T_2	—	40	—	T_{CPH}
ENB(INTERNAL)-OEV TIME	T_3	—	23	—	T_{CPH}
ENB(INTERNAL)-POL TIME	T_4	—	157	—	T_{CPH}
STV PULSE WIDTH	—	—	1	—	T_H

NOTE : (1) $T_{HS} + T_{HA} < T_H$



6. OPTICAL CHARACTERISTICS (NOTE1)

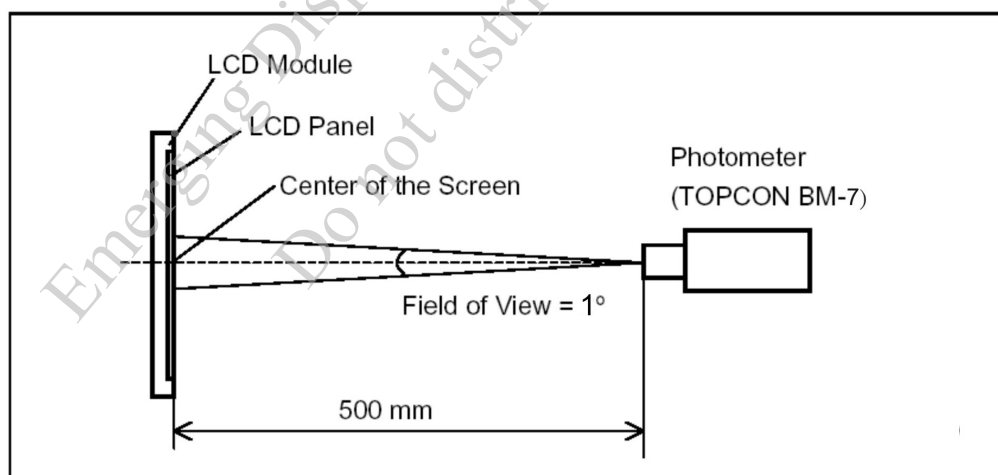
6.1 OPTICAL CHARACTERISTICS

Ta = 25 ± 2 °C

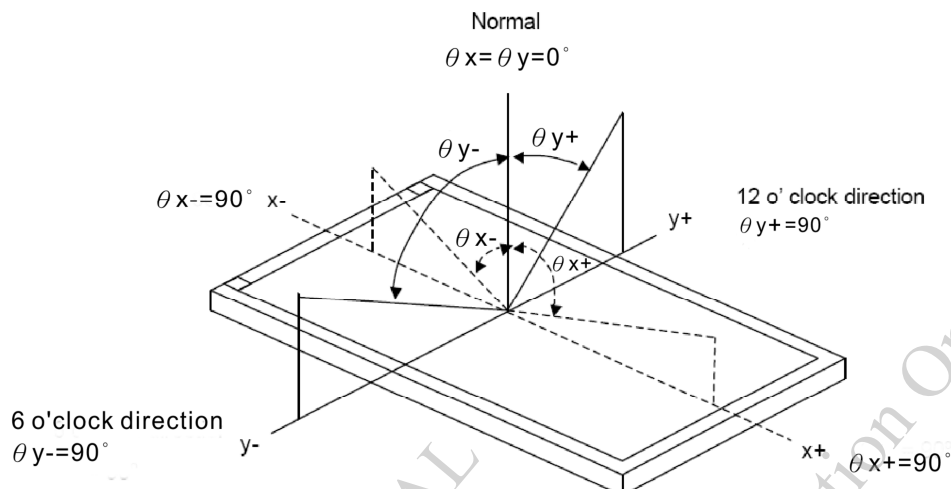
ITEM		SYMBOL	CONDITION		MIN.	TYP.	MAX.	UNIT	REMARK
VIEWING ANGLE		θ_{y+}	$CR \geq 10$	$\theta_x=0^\circ$	60	65	—	deg.	NOTE (2) NOTE (3)
		θ_{y-}			60	65	—		
		θ_{x+}		$\theta_y=0^\circ$	65	70	—		
		θ_{x-}			65	70	—		
CONTRAST RATIO		CR	$\theta_x=0^\circ$, $\theta_y=0^\circ$		300	350	—		NOTE (3)
RESPONSE TIME		T _R (rise)	$\theta_x=0^\circ$, $\theta_y=0^\circ$		—	5	10		NOTE (4)
		T _F (fall)			—	15	20		
COLOR OF CIE COORDINATE	WHITE	W _x	$\theta_x=0^\circ$, $\theta_y=0^\circ$ VCC-VSS=5V NTSC : 45 %		0.265	0.315	0.365	—	NOTE (5)
		W _y			0.295	0.355	0.43		
	RED	R _x			0.535	0.585	0.635	—	
		R _y			0.315	0.365	0.415		
	GREEN	G _x			0.28	0.33	0.38	—	
		G _y			0.57	0.62	0.67		
	BLUE	B _x			0.105	0.155	0.205	—	
		B _y			0.16	0.21	0.26		
THE BRIGHTNESS OF MODULE		B	$\theta_x=0^\circ$, $\theta_y=0^\circ$ VCC-VSS=5V		600	650	—	cd/m ²	NOTE (6)
THE UNIFORMITY OF MODULE		—			75	80	—	%	

NOTE (1) : TEST EQUIPMENT SETUP :

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



NOTE (2) : DEFINITION OF VIEWING ANGLE :

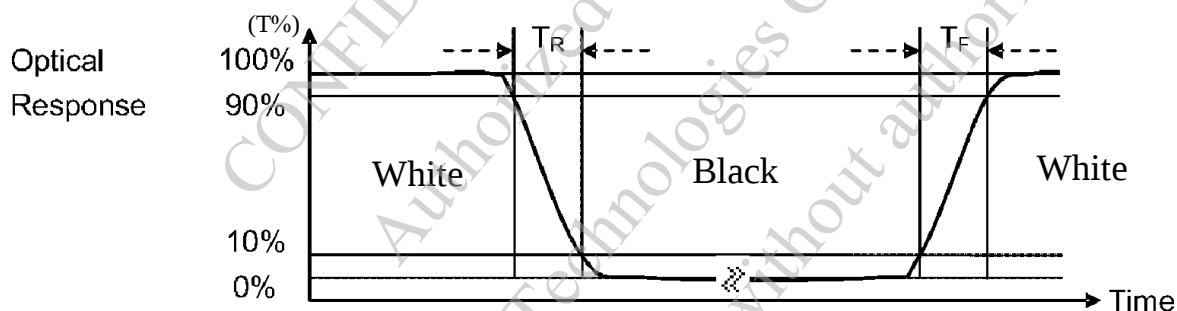


NOTE (3) : DEFINITION OF CONTRAST RATIO :

$$\text{CONTRAST RATIO(CR)} = \frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$$

NOTE (4) : DEFINITION OF RESPONSE TIME : TR AND TF

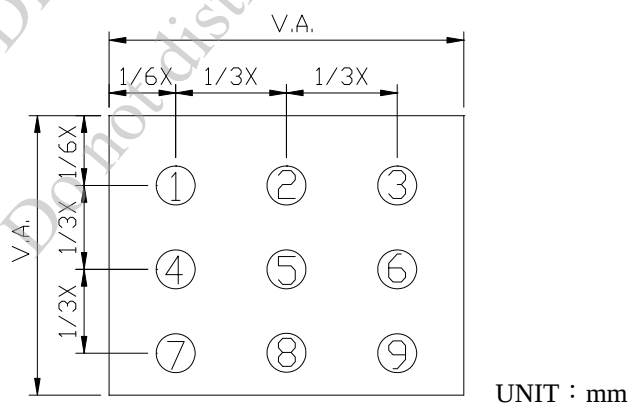
THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



NOTE (5) : THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.

NOTE (6) : BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE".

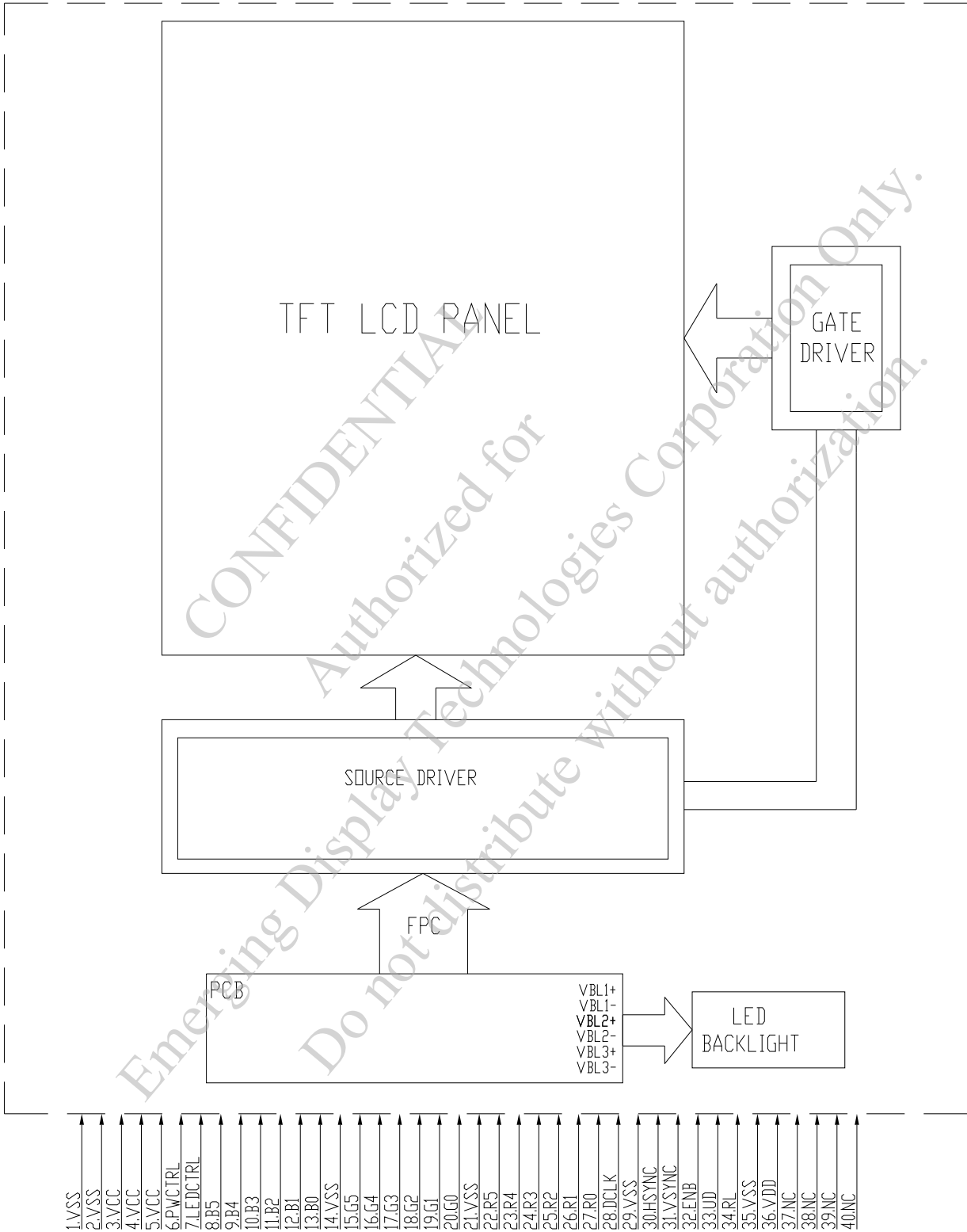
6.2 THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY



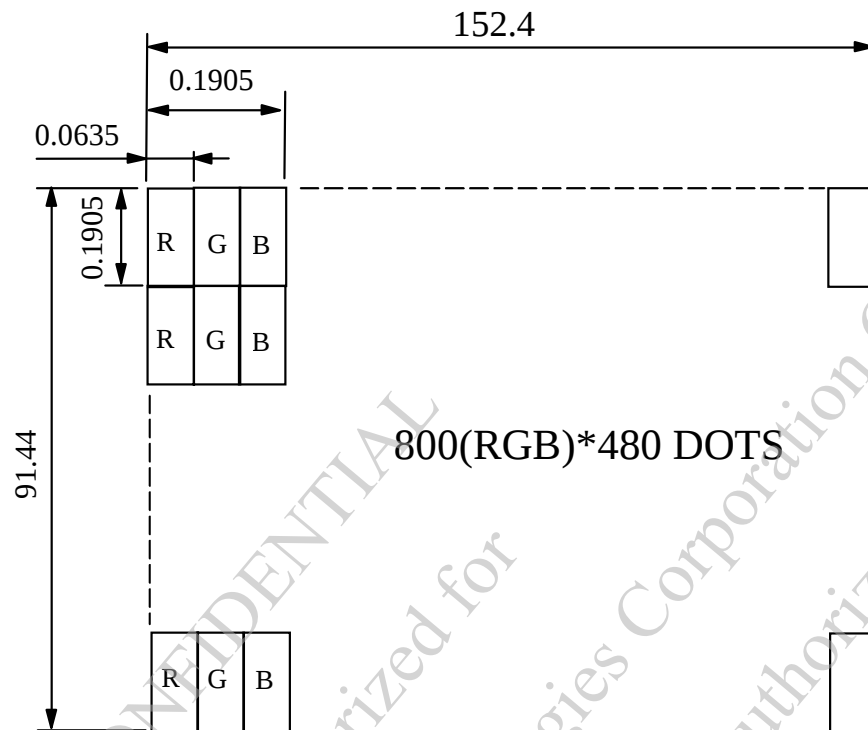
6.3 THE CALCULATING METHOD OF UNIFORMITY

$$\text{UNIFORMITY} = \left[1 - \frac{\text{MAXIMUM BRIGHTNESS} - \text{MINIMUM BRIGHTNESS}}{\text{AVERAGE BRIGHTNESS}} \right] \times 100\%$$

8. BLOCK DIAGRAM



9. DETAIL DRAWING OF DOT MATRIX



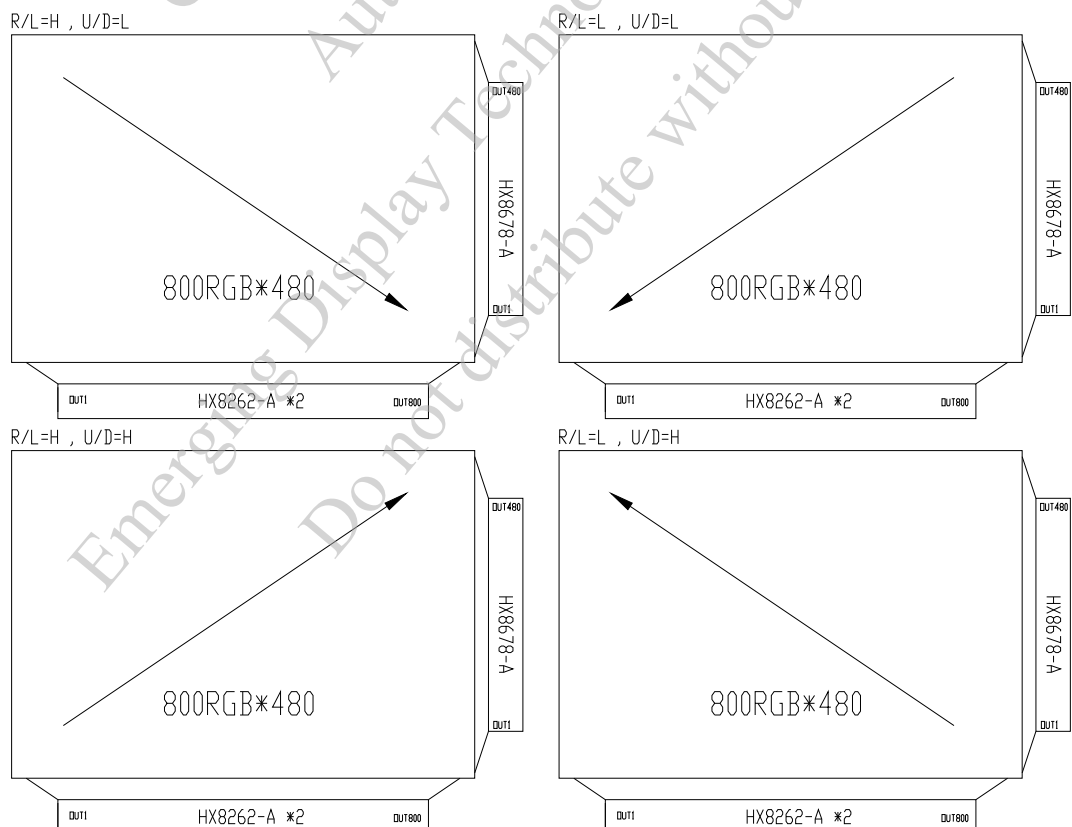
UNIT : mm
SCALE : NTS
NOT SPECIFIED TOLERANCE IS ± 0.1
DOTS MATRIX TOLERANCE IS ± 0.01

10. INTERFACE SIGNALS

PIN NO.	SYMBOL	I/O	FUNCTION		
1	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)		
2	VSS	P			
3	VCC	P	POWER SUPPLY FOR LED DRIVER CIRCUIT		
4	VCC	P	POWER SUPPLY FOR LED DRIVER CIRCUIT		
5	VCC	P	POWER SUPPLY FOR LED DRIVER CIRCUIT		
6	PWCTRL	I		PWCTRL	REMARK
			LOGIC LEVEL H=3.3V L=0V	H	POWER ON
				L	SHUTDOWN
7	LEDCTRL	I	BRIGHTNESS CONTROL FOR LED BACKLIGHT : POWER SUPPLY 0~2.5V OR PWM SIGNAL		
8	B5	I	BLUE DATA BIT 5		
9	B4	I	BLUE DATA BIT 4		
10	B3	I	BLUE DATA BIT 3		
11	B2	I	BLUE DATA BIT 2		
12	B1	I	BLUE DATA BIT 1		
13	B0	I	BLUE DATA BIT 0		
14	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)		
15	G5	I	GREEN DATA BIT 5		
16	G4	I	GREEN DATA BIT 4		
17	G3	I	GREEN DATA BIT 3		
18	G2	I	GREEN DATA BIT 2		
19	G1	I	GREEN DATA BIT 1		
20	G0	I	GREEN DATA BIT 0		
21	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)		
22	R5	I	RED DATA BIT 5		
23	R4	I	RED DATA BIT 4		
24	R3	I	RED DATA BIT 3		
25	R2	I	RED DATA BIT 2		
26	R1	I	RED DATA BIT 1		
27	R0	I	RED DATA BIT 0		
28	DCLK	I	DOT DATA CLOCK		
29	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)		

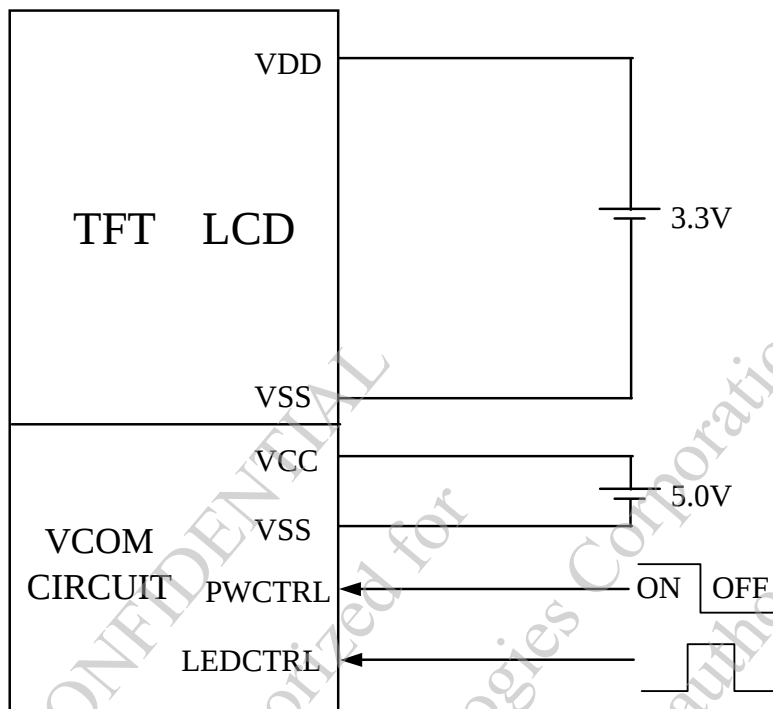
PIN NO.	SYMBOL	I/O	FUNCTION	
30	HSYNC	I	HORIZONTAL SYNC INPUT. INTERNALLY PULL HIGH.	DE & SYNC MODE SETTING DE MODE : ONLY ENB AND PIXEL CLOCK IS NECESSARY. SYNC MODE : ENB SHOULD BE CONNECTED TO VSS. HSYNC/VSYNC AND PIXEL CLOCK IS NECESSARY.
31	VSYNC	I	VERTICAL SYNC INPUT. INTERNALLY PULL HIGH.	
32	ENB	I	DATA ENABLE INPUT. INTERNALLY PULL LOW.	
33	UD	I	U/D=H : OUT1→OUT2→ ----- →OUT480 U/D=L : OUT480→ ----- →OUT2→ OUT1	
34	RL	I	R/L= H : OUT1→OUT2→ ----- →OUT800 R/L=L : OUT800→ ----- →OUT2→ OUT1	
35	VSS	P	GROUND (VSS IS CONNECTED TO METAL HOUSING WITH CONDUCTIVE TAPE)	
36	VDD	P	POWER SUPPLY VOLTAGE	
37	NC	—	NC	
38	NC	—	NC	
39	NC	—	NC	
40	NC	—	NC	

10.1 SELECTION OF SCANNING MODE



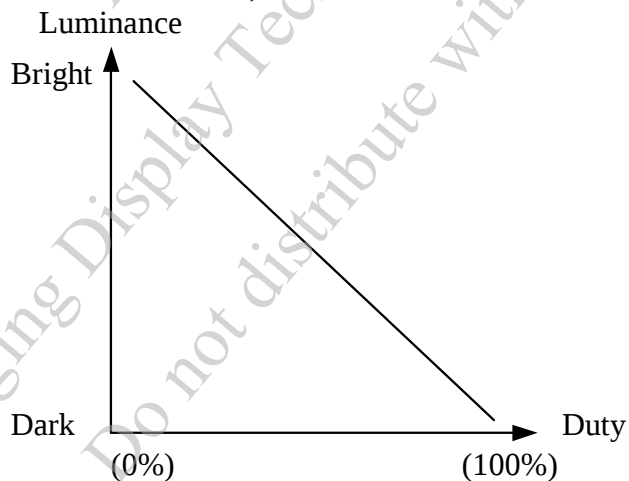
11. POWER SUPPLY

11.1 POWER SUPPLY FOR LCM

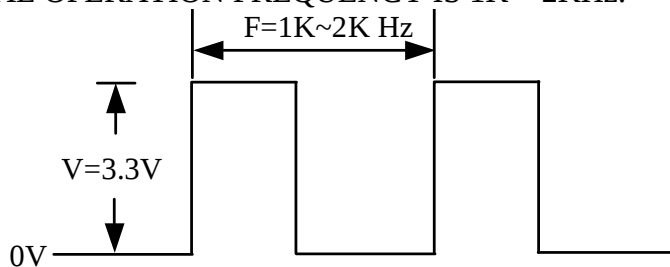


11.2 THE BRIGHTNESS CONTROLLED BY PWM SIGNAL OF LEDCTRL

(1) IF THE DUTY IS BIGGER, THE BRIGHTNESS WILL BE LOWER.



(2) SIGNAL OPERATION FREQUENCY IS 1K ~ 2KHz.



12. INSPECTION CRITERION

12.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) TO CUSTOMERS

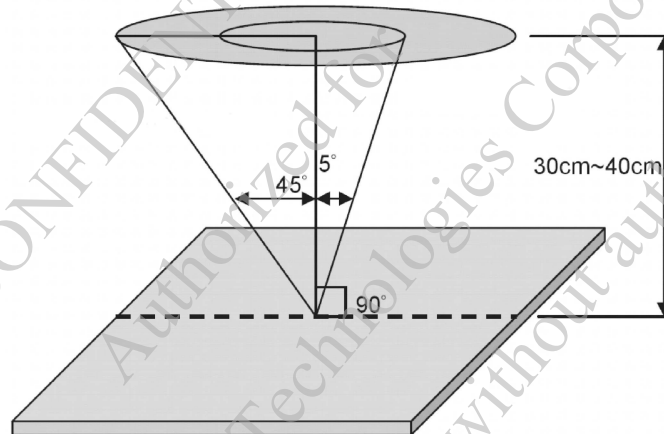
12.2 INSPECTION CONDITIONS

12.2.1 (1)OBSERVATION DISTANCE : 35CM $\pm$ 5CM

(2)VIEW ANGLE :

NON-OPERATION CONDITION : $\pm 5^\circ$ (PERPENDICULAR TO LCD PANEL SURFACE)

OPERATION CONDITION : $\pm 45^\circ$ (PERPENDICULAR TO LCD PANEL SURFACE)



12.2.2 ENVIRONMENT CONDITIONS :

AMBIENT TEMPERATURE		20°C~25°C
AMBIENT HUMIDITY		65 $\pm$ 20%RH
AMBIENT ILLUMINATION	COSMETIC INSPECTION	MORE THAN 600LUX
	FUNCTIONAL INSPECTION	300~500 LUX

12.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

12.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY

(A)APPLICABLE STANDARD : MIL-STD-105E

NORMAL INSPECTION , SINGLE
SAMPLING LEVEL II

(B)AQL : MAJOR DEFECT : AQL 0.65

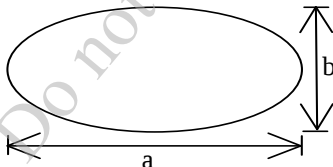
MINOR DEFECT : AQL 1.0

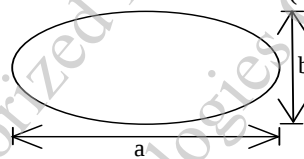
12.3 INSPECTION STANDARDS

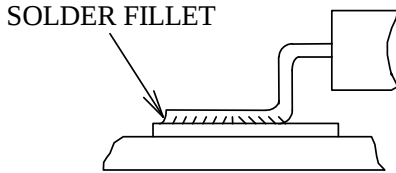
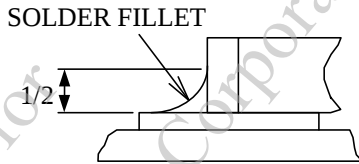
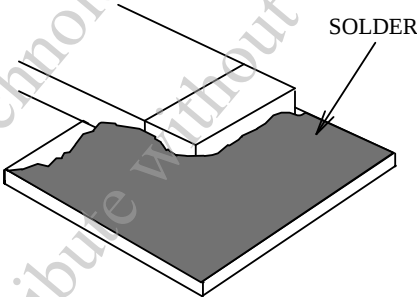
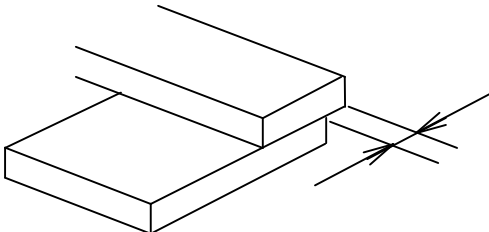
12.3.1 VISUAL DEFECTS CLASSIFICATION

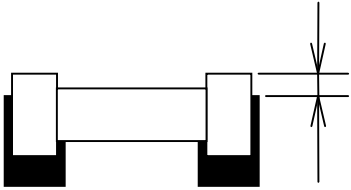
TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
MAJOR DEFECT	1.DISPLAY ON	• DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS - EX: DISCONNECTION, SHORT CIRCUIT ETC	0.65
	2.BACKLIGHT	• NO LIGHT • FLICKERING AND OTHER ABNORMAL ILLUMINATION	
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
MINOR DEFECT	1.DISPLAY ZONE	• BLACK/WHITE SPOT • BUBBLES ON POLARIZER • NEWTON RING • BLACK/WHITE LINE • SCRATCH • CONTAMINATION • LEVER COLOR SPREED	1.0
	2.BEZEL ZONE	• STAINS • SCRATCHES • FOREIGN MATTER	
	3.SOLDERING	• INSUFFICIENT SOLDER • SOLDERED IN INCORRECT POSITION • CONVEX SOLDERING SPOT • SOLDER BALLS • SOLDER SCRAPS	
	4.DISPLAY ON (ALL ON)	• LIGHT LINE	

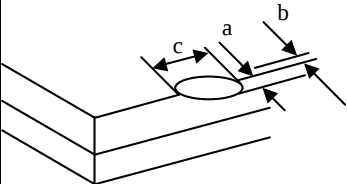
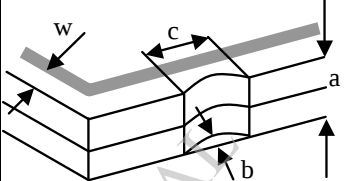
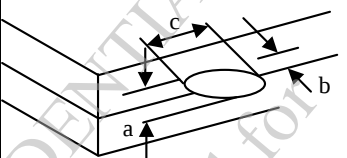
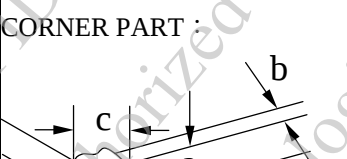
12.3.2 MODULE DEFECTS CLASSIFICATION

NO.	ITEM	CRITERIA												
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC												
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND SPEC												
3.	DOT DEFECT	(1) INSPECTION PATTERN: FULL WHITE, FULL BLACK, RED, GREEN AND BLUE SCREENS. (2)<table><tr><th>ITEMS</th><th>ACCEPTABLE COUNT</th></tr><tr><td>BRIGHT DOT</td><td>$N \leq 3$</td></tr><tr><td>DARK DOT</td><td>$N \leq 5$</td></tr><tr><td>TOTAL BRIGHT AND DARK DOTS</td><td>$N \leq 5$</td></tr></table> NOTE : 1. THE DEFINITION OF DOT : THE SIZE OF A DEFECTIVE DOT OVER 1/2 OF WHOLE DOT IS REGARDED AS ONE DEFECTUVE DOT. 2. BRIGHT DOT : DOTS APPEAR BRIGHT AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER BLACK PATTERN. 3. DARK DOT : DOTS APPEAR DARK AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER PURE RED, GREEN, BLUE PICTURE.	ITEMS	ACCEPTABLE COUNT	BRIGHT DOT	$N \leq 3$	DARK DOT	$N \leq 5$	TOTAL BRIGHT AND DARK DOTS	$N \leq 5$				
ITEMS	ACCEPTABLE COUNT													
BRIGHT DOT	$N \leq 3$													
DARK DOT	$N \leq 5$													
TOTAL BRIGHT AND DARK DOTS	$N \leq 5$													
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA	<table><tr><th>LENGTH : L</th><th>WIDTH : W</th><th>PERMISSIBLE NO.</th></tr><tr><td>$L \leq 0.3$</td><td>$W \leq 0.05$</td><td>IGNORE</td></tr><tr><td>$0.3 < L \leq 2.5$</td><td>$0.05 < W \leq 0.1$</td><td>4</td></tr><tr><td>$2.5 < L$</td><td>$0.1 < W$</td><td>NONE</td></tr></table> WIDTH : W mm, LENGH : L mm	LENGTH : L	WIDTH : W	PERMISSIBLE NO.	$L \leq 0.3$	$W \leq 0.05$	IGNORE	$0.3 < L \leq 2.5$	$0.05 < W \leq 0.1$	4	$2.5 < L$	$0.1 < W$	NONE
LENGTH : L	WIDTH : W	PERMISSIBLE NO.												
$L \leq 0.3$	$W \leq 0.05$	IGNORE												
$0.3 < L \leq 2.5$	$0.05 < W \leq 0.1$	4												
$2.5 < L$	$0.1 < W$	NONE												
5.	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	<table><tr><th>AVERAGE DIAMETER (mm): D</th><th>NUMBER OF PIECES PERMITTED</th></tr><tr><td>$D \leq 0.15$</td><td>IGNORE</td></tr><tr><td>$0.15 < D \leq 0.5$</td><td>4</td></tr><tr><td>$0.5 < D$</td><td>NONE</td></tr></table> NOTE : DIAMETER $D=(a+b)/2$ 	AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED	$D \leq 0.15$	IGNORE	$0.15 < D \leq 0.5$	4	$0.5 < D$	NONE				
AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED													
$D \leq 0.15$	IGNORE													
$0.15 < D \leq 0.5$	4													
$0.5 < D$	NONE													

NO.	ITEM	CRITERIA																				
6.	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	<table><tr><td></td><td>AVERAGE DIAMETER (mm) : D</td><td>NUMBER OF PIECES PERMITTED</td></tr><tr><td rowspan="3">BUBBLE ON THE POLARIZER</td><td>$D \leq 0.25$</td><td>IGNORE</td></tr><tr><td>$0.25 < D \leq 0.5$</td><td>$N \leq 5$</td></tr><tr><td>$0.5 < D$</td><td>NONE</td></tr><tr><td rowspan="2">SURFACE STAINS</td><td>$D < 0.1 \text{ mm}$</td><td>IGNORE</td></tr><tr><td>$0.1 < D \leq 0.3\text{mm}$</td><td>$N \leq 3$</td></tr><tr><td rowspan="2">CF FAIL / SPOT</td><td>$D < 0.1 \text{ mm}$</td><td>IGNORE</td></tr><tr><td>$0.1 < D \leq 0.3\text{mm}$</td><td>$N \leq 3$</td></tr></table>		AVERAGE DIAMETER (mm) : D	NUMBER OF PIECES PERMITTED	BUBBLE ON THE POLARIZER	$D \leq 0.25$	IGNORE	$0.25 < D \leq 0.5$	$N \leq 5$	$0.5 < D$	NONE	SURFACE STAINS	$D < 0.1 \text{ mm}$	IGNORE	$0.1 < D \leq 0.3\text{mm}$	$N \leq 3$	CF FAIL / SPOT	$D < 0.1 \text{ mm}$	IGNORE	$0.1 < D \leq 0.3\text{mm}$	$N \leq 3$
			AVERAGE DIAMETER (mm) : D	NUMBER OF PIECES PERMITTED																		
		BUBBLE ON THE POLARIZER	$D \leq 0.25$	IGNORE																		
			$0.25 < D \leq 0.5$	$N \leq 5$																		
			$0.5 < D$	NONE																		
		SURFACE STAINS	$D < 0.1 \text{ mm}$	IGNORE																		
			$0.1 < D \leq 0.3\text{mm}$	$N \leq 3$																		
		CF FAIL / SPOT	$D < 0.1 \text{ mm}$	IGNORE																		
			$0.1 < D \leq 0.3\text{mm}$	$N \leq 3$																		
		NOTE : (1)POLARIZER BUBBLE IS DEFINED AS THE BUBBLE APPEARS ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA. (2)THE EXTRANEIOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON. (3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING. AVERAGE DIAMETER (D)=(a+b)/2																				
																						
7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOWED																				
8.	MURA ON DISPLAY	NOT VISIBLE THROUGH 6% ND FILTER OR JUDGED BY LIMIT SAMPLE IF NECESSARY.																				
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.																				
10.	BEZEL APPEARANCE	(1)BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION. (2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.																				
11.	PCB	(1)THERE MAY NOT BE MORE THAN 2mm OF SEALANT OUTSIDE THE SEAL AREA ON THE PCB, AND THERE SHOULD BE NO MORE THAN THREE PLACES. (2)NO OXIDATION OR CONTAMINATION PCB TERMINALS. (3)PARTS ON PCB MUST BE THE SAME AS ON THE PRODUCTION CHARACTERISTIC CHART. THERE SHOULD BE NO WRONG PARTS, MISSING PARTS OR EXCESS PARTS. (4)THE JUMPER ON THE PCB SHOULD CONFORM TO THE PRODUCT CHARACTERISTIC CHART. (5)IF SOLDER GETS ON BEZEL TAB PADS, LED PAD, ZEBRA PAD OR SCREW HOLD PAD: MAKE SURE IT IS SMOOTHED DOWN.																				

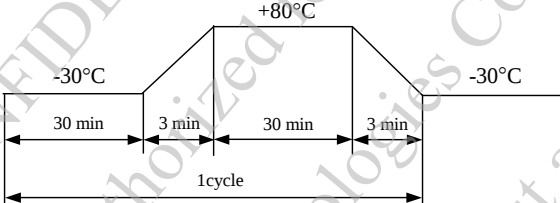
NO.	ITEM	CRITERIA
12.	SOLDERING	(1)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICIENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD  (b)CHIP COMPONENT - SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING  - SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED  (3)PARTS ALIGMENT (a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE 

NO.	ITEM	CRITERIA
12.	SOLDERING	(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE  (4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. (6)NO RESIDUE OR SOLDER BALLS ON PCB. (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.
13.	BACKLIGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
14.	GENERAL APPEARANCE	(1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. (2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP. (3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. (4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. (5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. (6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. (7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. (8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. (9)LCD PIN LOOSE OR MISSING PINS. (10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. (11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. (12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK..

NO.	ITEM	CRITERIA									
15.	CRACKED GLASS	THE LCD WITH EXTENSIVE CRACK IS NOT ACCEPTABLE									
		GENERAL GLASS CHIP :  <table><tr><th>a</th><th>b</th><th>c</th></tr><tr><td>$\leq t/2$</td><td>< VIEWING AREA</td><td>$\leq 1/8X$</td></tr><tr><td>$t/2 >, \leq 2t$</td><td>$\leq W/2$</td><td>$\leq 1/8X$</td></tr></table> *W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS	a	b	c	$\leq t/2$	< VIEWING AREA	$\leq 1/8X$	$t/2 >, \leq 2t$	$\leq W/2$	$\leq 1/8X$
		a	b	c							
		$\leq t/2$	< VIEWING AREA	$\leq 1/8X$							
$t/2 >, \leq 2t$	$\leq W/2$	$\leq 1/8X$									
CORNER PART :  <table><tr><th>a</th><th>b</th><th>c</th></tr><tr><td>$\leq t/2$</td><td>< VIEWING AREA</td><td>$\leq 1/8X$</td></tr><tr><td>$> t/2, \leq 2t$</td><td>$\leq W/2$</td><td>$\leq 1/8X$</td></tr></table> *W=DISTANCE BETWEEN SEALANT AREA AND LCD PANEL EDGE X = LCD SIDE LENGTH t = GLASS THICKNESS	a	b	c	$\leq t/2$	< VIEWING AREA	$\leq 1/8X$	$> t/2, \leq 2t$	$\leq W/2$	$\leq 1/8X$		
a	b	c									
$\leq t/2$	< VIEWING AREA	$\leq 1/8X$									
$> t/2, \leq 2t$	$\leq W/2$	$\leq 1/8X$									
CHIP ON ELECTRODE PAD  <table><tr><th>a</th><th>b</th><th>c</th></tr><tr><td>$\leq t$</td><td>$\leq 0.5mm$</td><td>$\leq 1/8X$</td></tr></table> * X=LCD SIDE WIDTH t =GLASS THICKNESS	a	b	c	$\leq t$	$\leq 0.5mm$	$\leq 1/8X$					
a	b	c									
$\leq t$	$\leq 0.5mm$	$\leq 1/8X$									
		 <table><tr><th>a</th><th>b</th><th>c</th></tr><tr><td>$\leq t$</td><td>$\leq 1/8X$</td><td>$\leq L$</td></tr></table> *X=LCD SIDE WIDTH t = GLASS THICKNESS L=ELECTRODE PAD LENGTH ①IF GLASS CHIPPING THE ITO TERMINAL, OVER 2/3 OF THE ITO MUST REMAIN AND BE, INSPECTED ACCORDING TO ELECTRODE TERMINAL SPECIFICATIONS ②IF THE PRODUCT WILL BE HEAT SEALED BY THE CUSTOMER, THE ALIGNMENT MARK MUST NOT BE DAMAGED	a	b	c	$\leq t$	$\leq 1/8X$	$\leq L$			
a	b	c									
$\leq t$	$\leq 1/8X$	$\leq L$									

12.4 RELIABILITY TEST

12.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO.	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
5	HIGH TEMP / HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION : 
7	ESD (ELECTROSTATIC DISCHARGE) (NOT OPERATED)	AIR DISCHARGE $\pm 12\text{KV}$ CONTACT DISCHARGE $\pm 8\text{KV}$ ACCORDING TO IEC-61000-4-2

NOTE (1) : THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

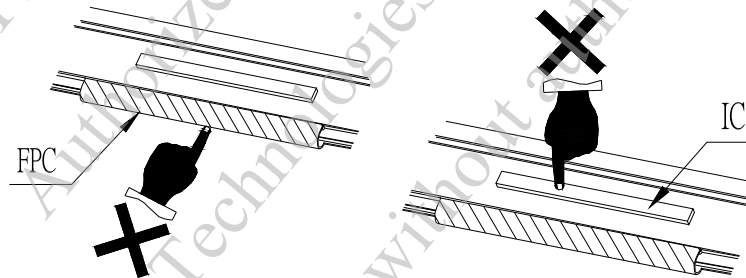
12.5 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 12.5, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO.	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE.

12.6 OPERATION

- 12.6.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED.
- 12.6.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE ; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY ; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 12.6.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST.
- 12.6.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.
IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH - UP PROBLEM.
- 12.6.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!
DO NOT STRESS FPC AND IC ON THE MODULE!



12.7 NOTICE

- 12.7.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD .
- 12.7.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 12.7.3 DO NOT CHARGE STATIC ELECTRICITY , AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL .
- 12.7.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE ; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE .
- 12.7.5 DON'T GIVE EXTERNAL SHOCK.
- 12.7.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 12.7.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.
WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 12.7.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 12.7.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 12.7.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 12.7.11 REWIRING: NO MORE THAN 3 TIMES.